**BTEC Assignment Brief**

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| **Qualification** | Pearson BTEC Level 3 National Extended Diploma in Engineering  |
| **Unit number and title** | **Unit 22: Electronic Printed Circuit Board Design and Manufacture** |
| **Learning aim(s)** (For NQF only) | **A:** Examine the design and manufacture of printed circuit boards that are widely used in industry |
| **Assignment title** | Printed circuit board technology and manufacture. |
| **Assessor – J Kupper** |
| **Issue date** | 10/01/2022 |
| **Hand in deadline**  | 31/01/2022 |
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| **Vocational Scenario or Context** | You have started an Apprenticeship with a company that specialises in manufacturing printed circuit boards (PCB) for other companies to put into their products. Some customers provide the printed circuit board design layouts, but others only supply the circuit schematic, which your company turns into a PCB layout. Your Supervisor has asked you to carry out an investigation to familiarise yourself with the range of boards that your company provides, including their practical advantages and limitations. |
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| **Task 1** | You have been asked to investigate and evaluate at least two different printed circuit boards that are contained within two products. The circuit architecture of the PCBs, and intended application of the products containing PCBs should be significantly different. **To do this:**You need to select two products that contain PCBs, making sure that the type of PCB used in each is different. You need to:* Research the manufacture and technologies of at least two different types of printed circuit board.
* Investigate the reasons for the use of each type of circuit board in the products you have selected.

**You then need to:*** Produce either a written report, or deliver a formal presentation that compares and contrasts the two types of circuit board, and includes information about the technology used for each type of printed circuit board;
* the characteristics of each type of printed circuit board, including factors such as size, materials used, component attachment methods, connections and case mounting;
* how thermal management issues are dealt with in the design stage, including the causes and consequences of heat gain;
* details of the manufacturing processes used (with illustrations) from raw materials through to testing, including information about the hardware and consumables that are needed;
* quality control methods (e.g. for small batch and mass production).
* Issues relating to sustainability and environmental considerations of the investigated technologies, including manufacturing and the product lifecycle.
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| **Checklist of evidence required**  | A written report or formal presentation detailing: * printed circuit board technology
* PCB characteristics
* thermal management techniques
* PCB manufacturing processes
* quality control methods.
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| **Criteria covered by this task:** |
| Unit/Criteria reference | To achieve the criteria you must show that you are able to: |
| 22/A.D1 | Evaluate, using vocational and high quality written language, the design and manufacture of at least two different printed circuit boards contained in products and consider how they are likely to evolve.  |
| 22/A.M1 | Analyse the design and the manufacture of at least two different printed circuit boards contained in products.  |
| 22/A.P1 | Explain the technology used in and characteristics of at least two different printed circuit boards contained in products.  |
| 22/A.P2 | Explain the causes and consequences of heat gain and thermal management methods used in at least two different printed circuit boards contained in products.  |
| 22/A.P3 | Explain the manufacturing processes and quality control methods used in at least two different printed circuit boards contained in products.  |
| **Sources of information to support you with this Assignment** | BooksMaking printed circuit boards; Axelson J L; Tab Electronics (1993); ISBN-13: 978-0830639519Make Your Own PCBs with EAGLE: From Schematic Designs to Finished Boards; Monk S; McGraw-Hill Education TAB (1994); ISBN-13: 978-0071819251 websites<https://learn.sparkfun.com/tutorials/pcb-basics><http://www.pcb.electrosoft-engineering.com/04-articles-custom-system-design-and-pcb/01-printed-circuit-board-concepts/printed-circuit-board-pcb-concepts.html> **Above are some examples of websites. Further useful resources may be found at**<http://qualifications.pearson.com/en/support/published-resources.html#step1> |
| **Other assessment materials attached to this Assignment Brief** | Two different types of printed circuit from common products (examples of THC, SMT or hybrid technology).1 X Picaxe 18M2 microcontroller board1 X Other example of double sided PCB chosen from this link or that you can find physically. <https://www.cnfastpcb.com/double-sided-pcb/> |